■ Power Inductor — EBP10 A Series

■ Application

— Laptops and PCs

— Switch and servers

— Base stations

— DC/DC converters

— Battery powered devices

— SSD modules

■ Features

— ROHS，Halogen Free and REACH compliance.

— High rated current.

— Operating temperature -55℃~+125℃(Including self - temperature rise) .

— Low core loss.

— Ultra low buzz noise due to molding construction.

■ Parts Number Explanation

Example:

EBP	1030	A	—	R47	M	—	T	W	Z
Product Type	**Size (mm)**	**Application**		**Inductance（uH）**	**Tolerance**		**Package**	**Internal Code**	**Optional**
Molding Power Inductor	1030 1040 1050			R47：0.47uH R68：0.68uH	M：±20%		T：Taping		Z：Default Code

Standard Electrical Specifications

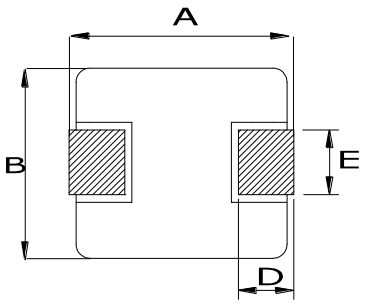
Part No.	Inductance	DC Resistance	Saturation Current	Heating Rating Current
	L0 (μH)	DCR (mΩ)	Isat (A)	Irms (A)
	±20 %, 100 kHz, 1V	MAX.	TYP.	TYP.
EBP1030A-R22M-TWZ	0.22	1.2	50	33
EBP1030A-R33M-TWZ	0.33	1.6	32	23
EBP1030A-R36M-TWZ	0.36	1.6	28	23
EBP1030A-R47M-TWZ	0.47	2.5	26	22
EBP1030A-R82M-TWZ	0.82	3.7	23	18
EBP1030A-1R0M-TWZ	1.0	6	21	15
EBP1030A-2R2M-TWZ	2.2	9	14	11
EBP1030A-3R3M-TWZ	3.3	16	12	9
EBP1030A-4R7M-TWZ	4.7	24	10	7
EBP1030A-8R2M-TWZ	8.2	45	7	5
EBP1030A-330M-TWZ	33	160	4	2.6
EBP1040A-R15M-TWZ	0.15	0.65	75	45
EBP1040A-R22M-TWZ	0.22	1	60	35
EBP1040A-R30M-TWZ	0.3	1.1	45	35
EBP1040A-R36M-TWZ	0.36	1.2	45	30
EBP1040A-R47M-TWZ	0.47	1.7	40	30
EBP1040A-R56M-TWZ	0.56	1.8	33	25
EBP1040A-R68M-TWZ	0.68	2.4	30	23
EBP1040A-R80M-TWZ	0.8	2.7	29	23
EBP1040A-1R0M-TWZ	1.0	3.3	28	19
EBP1040A-1R5M-TWZ	1.5	4.2	24	16
EBP1040A-2R2M-TWZ	2.2	7	16.5	12
EBP1040A-3R3M-TWZ	3.3	11.8	16	11
EBP1040A-4R7M-TWZ	4.7	20	13	9
EBP1040A-6R8M-TWZ	6.8	25	12	8.5
EBP1040A-8R2M-TWZ	8.2	27	9	8
EBP1040A-100M-TWZ	10	30	8.5	7.8
EBP1040A-150M-TWZ	15	45	7	6.5
EBP1040A-220M-TWZ	22	66	5.5	5
EBP1040A-330M-TWZ	33	92	4.8	4.4

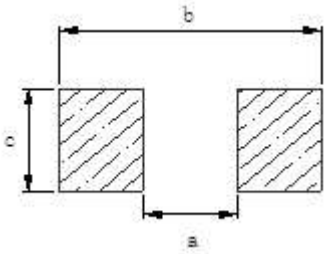
Part No.	Inductance	DC Resistance	Saturation Current	Heating Rating Current
	L0 (μH)	DCR (mΩ)	Isat (A)	Irms (A)
	±20 %, 100 kHz, 1V	MAX.	TYP.	TYP.
EBP1040A-470M-TWZ	47	145	3.5	3.3
EBP1040A-680M-TWZ	68	195	3	2.5
EBP1040A-820M-TWZ	82	285	2.8	2.3
EBP1040A-101M-TWZ	100	340	2.3	2
EBP1050A-R22M-TWZ	0.22	0.8	65	37
EBP1050A-1R0M-TWZ	1.0	3	30	23
EBP1050A-1R5M-TWZ	1.5	3.8	25	21
EBP1050A-2R2M-TWZ	2.2	6	19	15
EBP1050A-3R3M-TWZ	3.3	10	16	13
EBP1050A-4R7M-TWZ	4.7	14	15	11
EBP1050A-5R6M-TWZ	5.6	17	14	9.5
EBP1050A-6R8M-TWZ	6.8	18.5	14	9
EBP1050A-100M-TWZ	10	28	10	8
EBP1050A-150M-TWZ	15	42	7.5	6.5
EBP1050A-220M-TWZ	22	50	6	5.5
EBP1050A-330M-TWZ	33	86	5.2	4.8
EBP1050A-470M-TWZ	47	127	4.5	3.7
EBP1050A-101M-TWZ	100	290	2.8	2.1

Notes:

1. All test data is referenced to 25 °C ambient
2. Operating temperature range - 55 °C to + 125 °C
3. Irms (A):DC current (A) that will cause an approximate ΔT of 40 °C(reference ambient temperature is 25 °C)
4. Isat(A):DC current (A) that will cause L0 to drop approximately 30 %
5. The part temperature (ambient + temp rise) should not exceed 125 °C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

■ Dimensions





Recommend Land Pattern

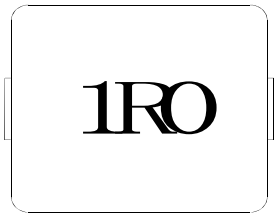
Unit: mm

Type	A	B	C	D	E	a typ	b typ	c typ
EBP1030A	11.5 max	10.0 ±0.3	2.8 ±0.2	2.0 ±0.3	3.0 ±0.3	5.4	13.6	4.1
EBP1040A	11.5 max.	10.0 ±0.3	3.8 ±0.2	2.0 ±0.3	3.0 ±0.5	5.4	13.6	4.1
EBP1050A	11.5 max	10.0 ±0.3	4.8 ±0.2	2.0 ±0.3	3.0 ±0.3	5.4	13.6	4.1

■ Marking

● The inductor is marked with a 3-digit code

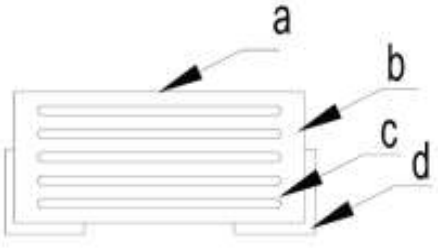
Nominal Inductance	
Example	Nominal Value
1R0	1.0 μH
100	10 μH
101	100 μH



Note：Using Ink for marking

■ Structure and Components

Symbol	Components	Material
a	MARKING	Ink (black)
b	CORE	Alloy Sponge Powder
c	WIRE	Polyurethane copper wire
d	TERMINAL	Copper plated with Sn



● Reliability test and requirement

Mechanical Reliability		
Item	**Specification and Requirement**	**Test Method**
Solderability	1. No case deformation or change in apperarance 2. New solder coverage More than 95%	1.Preheat：155℃±5℃ ，60S±2S 2.Tin: lead-free. 3.Temperature:240℃±5℃，flux 3.0S±0.5S.
Mechanical shock	1. No case deformation or change in apperarance 2. △L/Lo≦±10%	1. Acceleration： 100G 2. Pulse time:：6ms 3. 3 times in each positive and negative direction of 3 mutual perpendicular directions
Mechanical vibration	1. No case deformation or change in apperarance 2. △L/Lo≦±10%	1. Reflow: 2times 2. Frequency: 10HZ～55HZ～10HZ，20 Min/Cycles 3. Amplitude: 1.52 mm 4. Directions: X,Y,Z 5. Time: 12 cycle / direction
Endurance Reliability		
Item	**Specification and Requirement**	**Test Method**
Thermal Shock	Inductance change: Within ± 10% Without distinct damage in appearance	1. First -55℃ for 30 minutes，last 125℃ for 30 minutes as 1 cycle. Go through 1000 cycles. 2. Max transfer time is 3 minutes. 3. Measured at room temperature after placing for 24±2 hours
Humidity Resistance	Inductance change: Within ± 10% Without distinct damage in appearance	1.Reflow 2 times, 2.85℃,85%RH,1000 hours 3.Measured at room temperature after placing for 24±2 hours
Low temperature storage	Inductance change: Within ± 10% Without distinct damage in appearance	1. Temperature：-55 ± 2℃ 2. Time：1000 hours 3. Measured at room temperature after placing for 24±2 hours
High temperature storage	Inductance change: Within ± 10% Without distinct damage in appearance	1. Temperature：+125 ± 2℃ 2. Time：1000 hours 3. Measured at room temperature after placing for 24±2 hours

■ Recommended Soldering Technologies:

(1) Re-flowing Profile

Preheat condition: 150 ~200℃/60~180sec.

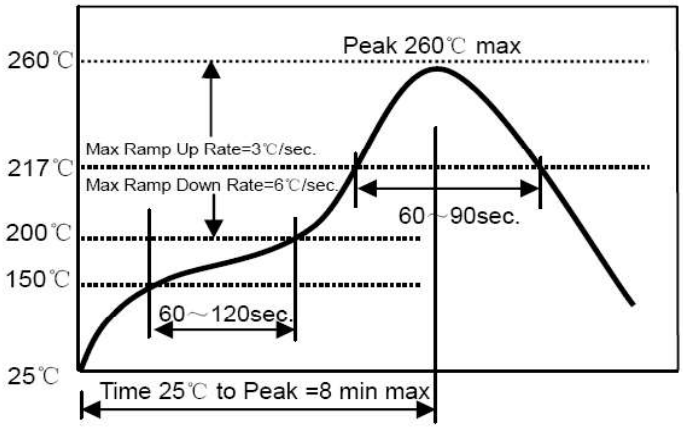
Allowed time above 217℃: 80~120sec.

Max temp: 260℃

Max time at max temp: 10 sec.

Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2x max



(2) Iron Soldering Profile

Iron soldering power: Max. 30W

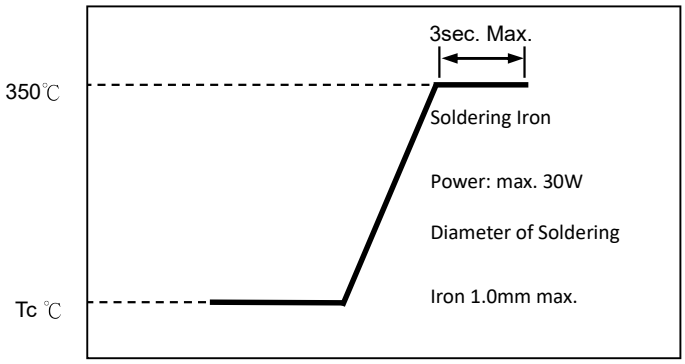
Pre-heating: 150℃/60sec.

Soldering Tip temperature: 350℃ Max.

Soldering time: 3sec. Max.

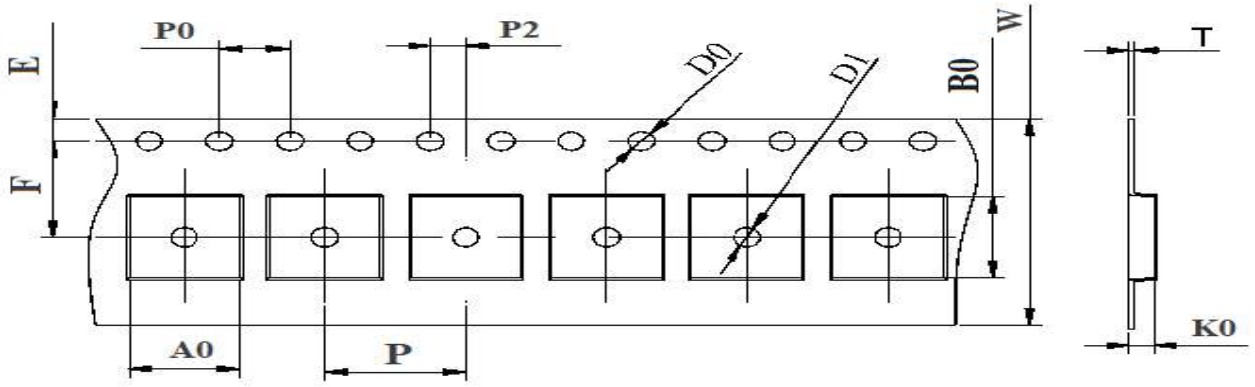
Solder paste: Sn/3.0Ag/0.5Cu

Max.1 times for iron soldering



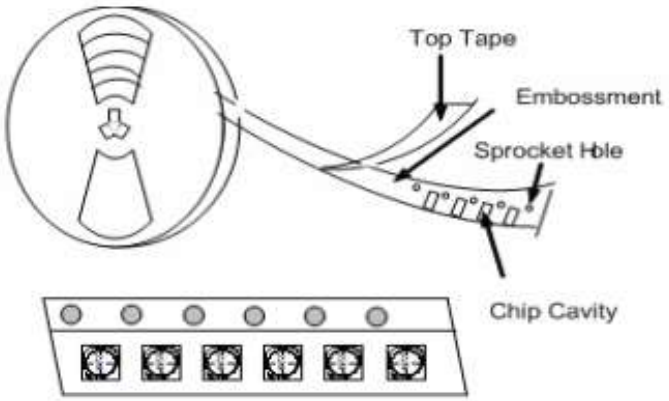
■ Packaging Information

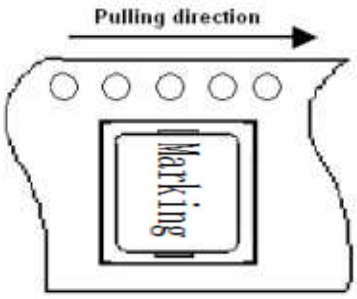
(1) Tape Packaging Dimensions（Unit：mm）



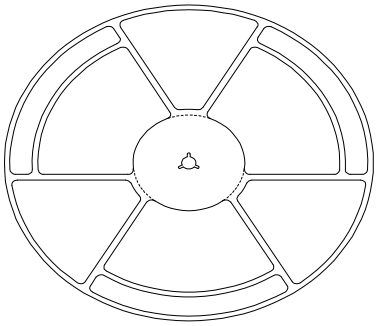
Type	Tape dimensions (mm)											
	W	P	P0	P2	D0	D1	T	A0	B0	K0	E	F
EBP1030A	24±0.3	16±0.1	4±0.1	2±0.05	1.5±0.1	1.5±0.1	0.35±0.05	10.4±0.1	11.6±0.1	3.3±0.1	1.75±0.1	11.5±0.1
EBP1040A	24±0.3	16±0.1	4±0.1	2±0.05	1.5±0.1	1.5±0.1	0.35±0.05	10.4±0.1	11.6±0.1	4.3±0.1	1.75±0.1	11.5±0.1
EBP1050A	24±0.3	16±0.1	4±0.1	2±0.05	1.5±0.1	1.5±0.1	0.40±0.05	10.4±0.1	11.6±0.1	5.4±0.1	1.75±0.1	11.5±0.1

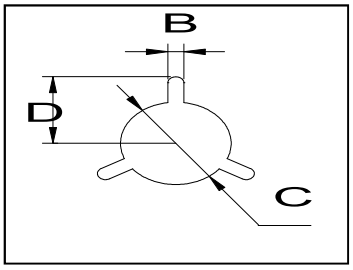
(2) Taping Drawings (Unit : mm)

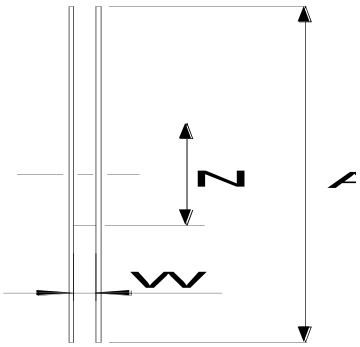




(3) Reel Dimensions（Unit：mm）







Type	Reel dimensions (mm)					
	A	W	N	B	C	D
EBP1030A	330 +2.0	24.0 ±0.5	97.0 ±0.5	2.20 +0.5	13.0 ±0.2	10.75 ±0.25
EBP1040A	330 +2.0	24.0 ±0.5	97.0 ±0.5	2.20 +0.5	13.0 ±0.2	10.75 ±0.25
EBP1050A	330 +2.0	24.0 ±0.5	97.0 ±0.5	2.20 +0.5	13.0 ±0.2	10.75 ±0.25

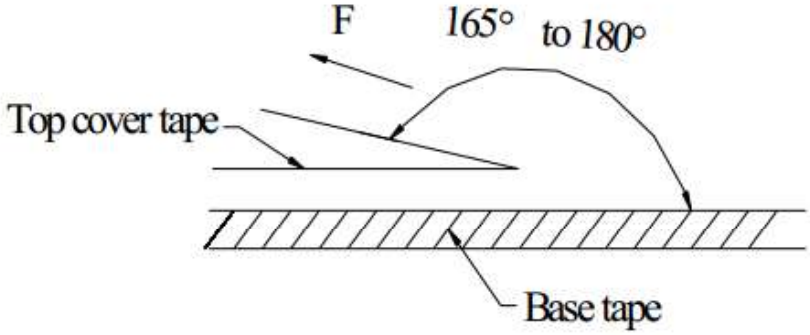
(4) Packaging Quantity(PCS)

Type	Standard Quantity		
	Reel	Inner box	Carton box
EBP1030A	800 pcs / reel	2Reel / box (1,600 pcs)	4 Middle boxes, (6,400 pcs)
EBP1040A	500 pcs / reel	2Reel / box (1,000 pcs)	4 Middle boxes, (4,000 pcs)
EBP1050A	500 pcs / reel	2Reel / box (1,000 pcs)	4 Middle boxes, (4,000 pcs)

(5) Peel force of top cover tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall be between 0.1 to 1.3 N



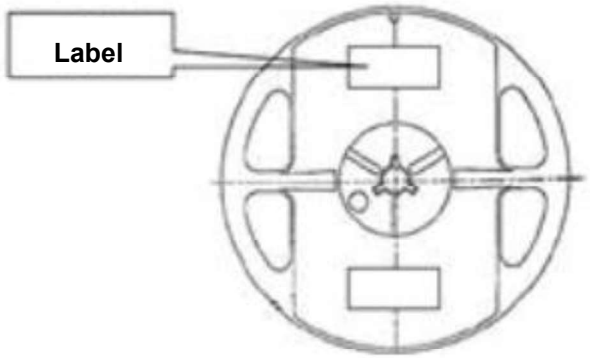
(6) Reel Label

●Label on the reel

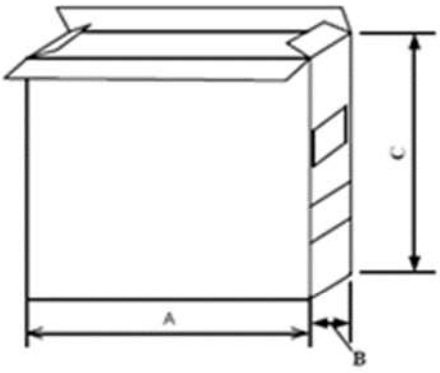
- Everohms part Number.
- Lot Number
- Quantity
- Description

●Shipping Label

- Customer's part Number
- Manufacturer's part Number
- Quantity
- date code

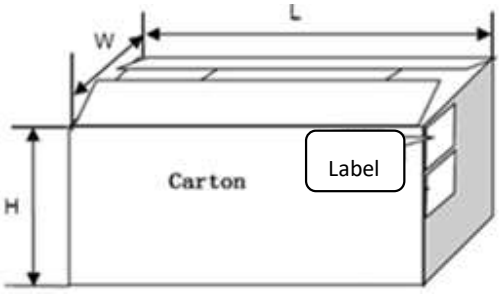


(7) Inner Box



Packaging Type	A (mm)	B (mm)	C (mm)
Inner box	335	70	340

(8) Carton



Packaging Type	L (mm)	W (mm)	H (mm)
Carton	360	360	360